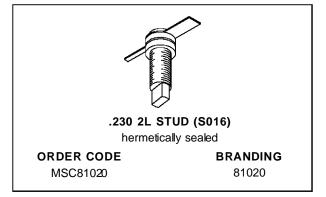
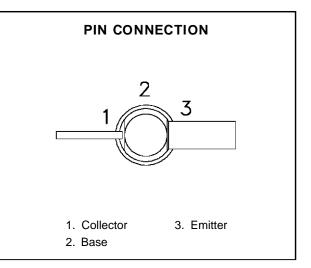


MSC81020

RF & MICROWAVE TRANSISTORS GENERAL PURPOSE AMPLIFIER APPLICATIONS

- EMITTER BALLASTED
- REFRACTORY/GOLD METALLIZATION
- LOW THERMAL RESISTANCE
- HERMETIC STRIPAC[®] PACKAGE
- $P_{OUT} = 20$ W MIN. WITH 10 dB GAIN @ 1 GHz





DESCRIPTION

The MSC81020 is a common base hermetically sealed silicon NPN microwave transitor utilizing a fishbone emitter ballasted geometry with a refractory/gold metallization system. This device is designed for Class C amplifier applications in the 0.4 - 1.2 GHz frequency range.

ABSOLUTE MAX	IMUM RATINGS	$(T_{case} = 25^{\circ}C)$
---------------------	--------------	----------------------------

Symbol	Parameter	Value	Unit
PDISS	Power Dissipation*	35	W
Ι _C	Device Current*	1.50	А
V _{CC}	Collector-Supply Voltage*	35	V
TJ	Junction Temperature	200	°C
T _{STG}	Storage Temperature	– 65 to +200	°C

THERMAL DATA

RTH(j-c)	Junction-Case Thermal Resistance*	5.0	°C/W	
*Applies only to rated RF amplifier operation				

MSC81020

ELECTRICAL SPECIFICATIONS $(T_{case} = 25^{\circ}C)$

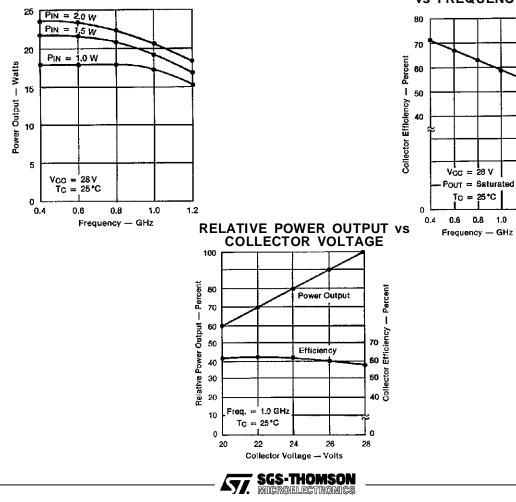
STATIC

Symbol Test Conditions		Toot Conditions		Value			Unit
	Min.	Тур.	Max.				
ВVсво	$I_C = 5mA$	$I_E = 0 m A$		45	—		V
BV _{EBO}	$I_E = 1 mA$	$I_C = 0 m A$		3.5	_		V
BV _{CER}	IC = 15mA	$R_{BE} = 10\Omega$		45	—	_	V
I _{CBO}	$V_{CB} = 28V$				—	5.0	mA
hFE	$V_{CE} = 5V$	$I_C = 1000 \text{mA}$		15	—	120	—

DYNAMIC

Cymph e l	Test Conditions			Value			
Symbol		Test Conditions	Test Conditions		Тур.	Max.	Unit
Роит	f = 1.0 GHz	$P_{IN} = 2.0 \text{ W}$	$V_{CC} = 28 V$	20	21	_	W
ηc	f = 1.0 GHz	$P_{IN} = 2.0 \text{ W}$	$V_{CC} = 28 V$	55	58	—	%
GP	f = 1.0 GHz	$P_{IN} = 2.0 \text{ W}$	$V_{CC} = 28 V$	10	10.2	—	dB
C _{OB}	f = 1 MHz	$V_{CB} = 28 V$		_		19	pF

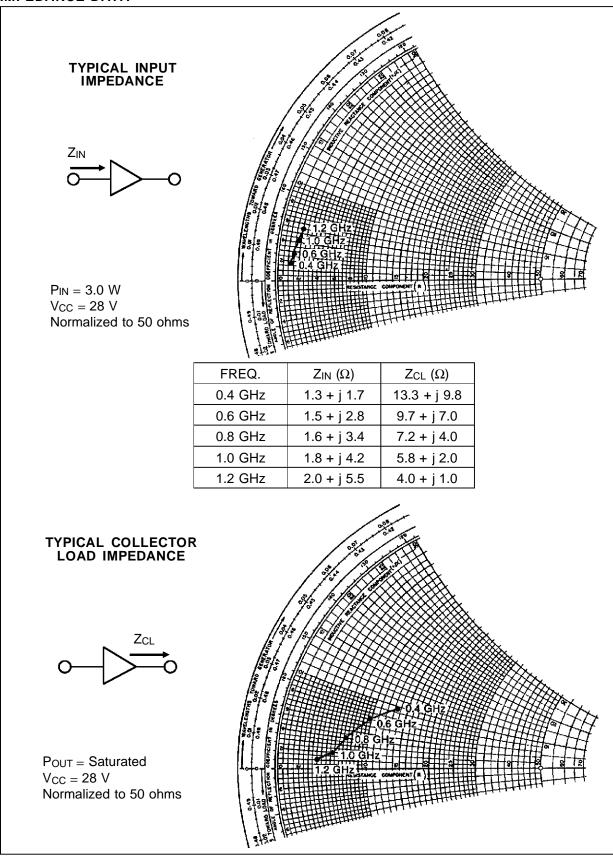
TYPICAL PERFORMANCE POWER OUTPUT vs FREQUENCY



COLLECTOR EFFICIENCY vs FREQUENCY

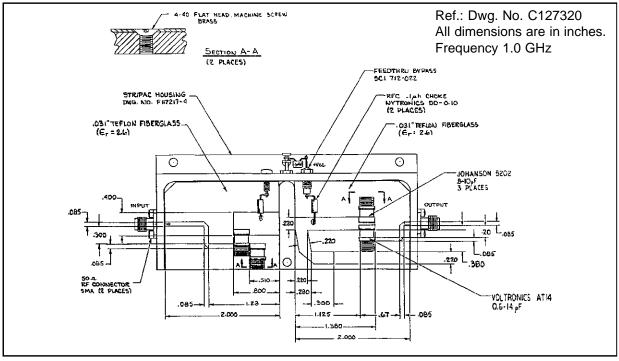
1.2

IMPEDANCE DATA

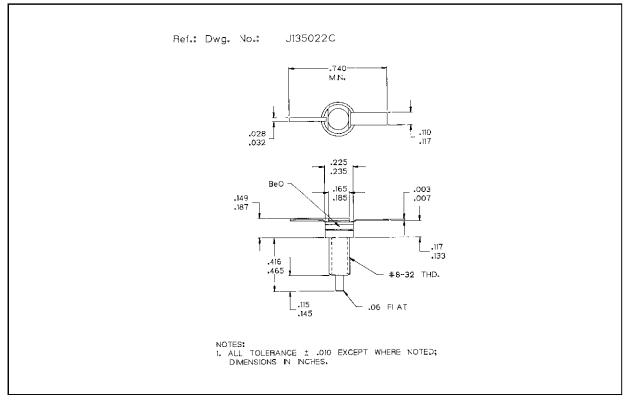


SGS-THOMSON MICROELECTRONICS

TEST CIRCUIT



PACKAGE MECHANICAL DATA





Information furnished is believed to be accurate and reliable. However, SGS-THOMSON Microelectronics assumes no responsability for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may results from its use. No license is granted by implication or otherwise under any patent or patent rights of SGS-THOMSON Microelectronics. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. SGS-THOMSON Microelectronics products are not authorized for use ascritical components in life support devices or systems without express written approval of SGS-THOMSON Microelectonics.

© 1994 SGS-THOMSON Microelectronics - All Rights Reserved

SGS-THOMSON Microelectronics GROUP OF COMPANIES

Australia - Brazil - France - Germany - Hong Kong - Italy - Japan - Korea - Malaysia - Malta - Morocco - The Netherlands -Singapore - Spain - Sweden - Switzerland - Taiwan - Thailand - United Kingdom - U.S.A

